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### Polarization-controlled modulation doping of a ferroelectric from first principles

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In a ferroelectric field effect transistor (FeFET), it is generally assumed that the ferroelectric gate plays a purely electrostatic role. Recently it has been shown that in some cases, which could be called "active FeFETs", electronic states in the ferroelectric contribute to the device conductance as the result of a modulation doping effect in which carriers are transferred from the channel into the ferroelectric layers near the interface. Here we report first-principles calculations and model analysis to elucidate the various aspects of this mechanism and to provide guidance in materials choices and interface termination for optimizing the on-off ratio, using BaTiO<sub>3</sub>/n-SrTiO<sub>3</sub> (electron-doped SrTiO<sub>3</sub>) and PbTiO<sub>3</sub>/n-SrTiO<sub>3</sub> as prototypical systems. It is shown that the modulation doping is substantial in both cases, and that the electrostatic model developed in previous work can be used to predict electron transfer. This model can thus be used to suggest additional materials heterostructures for the design of active FeFETs.

In a field-effect transistor, the conductance of the channel is modulated by a voltage applied between the gate and the base. A ferroelectric field-effect transistor (FeFET) is switched between high-conductance ON and low-conductance OFF states by switching the spontaneous polarization of the ferroelectric gate [1, 2]. If the role of the ferroelectric gate is purely electrostatic, then the difference in conductance between the up and down polarization states results from the change in channel carrier density that screens the depolarization field in the ferroelectric, and the concomitant change in the density of states at the Fermi level (Figure 1(a) and (b)). This change in carrier density is largest within a screening length of the interface. The fractional change in conductance, the "on-off ratio," is greatest when the carrier density of the bulk material of the channel is low, as in a doped semiconductor, complex oxide, or graphene sheet [3]. For example, modulation of the conductance by 300% was found in a PbZr<sub>0.2</sub>Ti<sub>0.8</sub>O<sub>3</sub>/La<sub>0.7</sub>Ca<sub>0.3</sub>MnO<sub>3</sub> heterostructure [4] and by more than 600% in PbZr<sub>0.2</sub>Ti<sub>0.8</sub>O<sub>3</sub>/graphene FeFETs [5].

Recent first-principles studies of ferroelectric heterostructures suggest that in some cases the modulation of the conductance is not solely due to the change in carrier density in the channel material, but can include active involvement of the ferroelectric, with significant contributions from interfacial electronic reconstruction [6, 7, 8, 9, 10] opening new high-conductivity channels in one polarization state (Figure 1(c)). The analysis of observed changes of conductance driven by ferroelectric polarization switching at a ferroelectric - complex oxide interface

PbZr<sub>0.2</sub>Ti<sub>0.8</sub>O<sub>3</sub>/LaNiO<sub>3</sub> [ 11 ] showed that a new conducting channel opened in the interface PbO layer for polarization pointing into the interface, with the bands in this layer shifting about 1.7 eV with the change in polarization state. First-principles investigation of the tunneling electroresistance perpendicular to the interface in a SrRuO<sub>3</sub>/BaTiO<sub>3</sub>/n-SrTiO<sub>3</sub> heterostructure operated as a ferroelectric tunnel junction showed metallization of two layers of BaTiO<sub>3</sub> at the BaTiO<sub>3</sub>/n-SrTiO<sub>3</sub> interface [12]. By recognizing that this heterostructure can also be operated as a FeFET, we here identify this as a simpler prototypical system in which a new conducting channel is opened in the ferroelectric interface layers for polarization pointing into the interface.

This behavior offers a promising avenue to enhance the on-off ratio in a FeFET by focusing on active involvement of the ferroelectric gate. The transfer of charge carriers into the ferroelectric gate via modulation doping is determined by the choice of materials and the terminations at the interface. The contribution to the conductance from the transferred carriers can be made larger than that of the carriers in the doped semiconductor by choice of a ferroelectric material with a high mobility for added carriers and the reduction of scattering by impurity dopants, which reside in the doped semiconductor.

In this paper, we report first-principles calculations and model analysis to elucidate the various aspects of this mechanism for conductivity switching and to provide guidance in materials choices and interface termination for optimizing the on-off ratio. We use BaTiO<sub>3</sub>/n-SrTiO<sub>3</sub> and PbTiO<sub>3</sub>/n-SrTiO<sub>3</sub> as prototypical systems. We show that the modulation doping is substantial in both cases and adapt an electrostatic model developed in previous work [12] to predict materials combinations in which electrons will be transferred into the ferroelectric in the ON state. This model can be used to suggest additional materials heterostructures for the design of active FeFETs.



Figure 1. A schematic of the effect of polarization direction on the conductance of a ferroelectric/dopedsemiconductor heterostructure. (a) For one choice of polarization direction, the majority charge carriers in the doped semiconductor are pushed away from the interface, reducing the conductivity and switching the device to the off state. (b) When the polarization direction is reversed, if the role of the ferroelectric is purely electrostatic, increase in carrier density and concomitant increase in the density of states at the Fermi level occurs only in the channel material within a screening length of the interface. (c) For an active ferroelectric gate, the carrier density also becomes nonzero in the ferroelectric layers adjacent to the interface through modulation doping, opening a new conducting channel (indicated by the green double-headed arrow) in the ferroelectric interface layers.

First-principles calculations were performed using Quantum ESPRESSO [13] within the local density approximation (LDA) and LDA+U. Ultrasoft pseudopotentials with plane-wave basis limited by a cutoff energy of 40 Ry were used, including 10 valence electrons for  $Sr(4s^24p^65s^2)$ , 10 for  $Ba(5s^25p^66s^2)$ , 11 for  $Ti(3s^23p^64s^23d^1)$ , 6 for  $O(2s^22p^4)$ . Nonzero U was included using the linear response method [14]. The Brillouin zone was sampled by a  $6 \times 6 \times 1$  mesh of k points. To simulate electron-doped SrTiO<sub>3</sub>, an electron concentration of 0.09 per formula unit was produced via a scaling of the oxygen pseudopotential in the SrTiO<sub>3</sub> layers (6.03 valence electrons for  $O(2s^22p^{4.03})$ ). With this low doping level and spatial distribution of compensating positive charge, the difference from the electronic structure of pure SrTiO<sub>3</sub> is negligible. The added electrons occupy the states at the conduction band minima, as they would for electron doping by Nb substitution for Ti or by oxygen vacancies.

considered 1x1  $(SrRuO_3)_5/(ATiO_3)_8/(n-$ We  $SrTiO_3)_{16}/(ATiO_3)_8/(SrRuO_3)_5$  (A = Ba, Pb) supercells stacked along the [001] direction with mirror symmetry around the central SrO atomic planes in the n-SrTiO<sub>3</sub> and SrRuO<sub>3</sub> layers. This supercell geometry avoids direct contact between the two electrode materials, SrRuO<sub>3</sub> and n-SrTiO<sub>3</sub>, and ensures full compatibility of arbitrary polarization of the ATiO<sub>3</sub> layers with periodic boundary conditions. As the role of SrRuO<sub>3</sub> in this system is only as a top electrode and carrier reservoir, we treat it as a nonmagnetic material with no rotational distortions. At both SrRuO<sub>3</sub>/ATiO<sub>3</sub> interfaces, ATiO<sub>3</sub> is terminated with  $TiO_2$ ; there is thus an extra  $TiO_2$  atomic layer in the system that should not affect the Fermi level as it is nominally charge neutral. The in-plane lattice constant of the supercell is constrained to the calculated LDA lattice constant of SrTiO<sub>3</sub>, a = 3.851 Å, which corresponds to an in-plane strain of about -2.1% on BaTiO<sub>3</sub> and -0.14% on PbTiO<sub>3</sub>. This epitaxial constraint stabilizes BaTiO<sub>3</sub> in the P4mm tetragonal phase with a spontaneous polarization of 40.9  $\mu$ C/cm<sup>2</sup> and *c* parameter of 4.101 Å. The tetragonal PbTiO<sub>3</sub> has a spontaneous polarization of 80.9  $\mu$ C/cm<sup>2</sup> and c parameter 4.032 Å. The ATiO<sub>3</sub>/n-SrTiO<sub>3</sub> interfaces are terminated with doped TiO<sub>2</sub>. The atomic positions are relaxed until forces are converged to less than 20 meV/Å on each atom, with the supercell constrained to be tetragonal so that only the c parameter is allowed to relax. Following Ref. [12], the layer-bylayer density of states is obtained by recomputing the electronic states of the relaxed structure with U = 5 eVfor the Ti d-states in the BaTiO<sub>3</sub> layer to correct artifacts arising from the LDA underestimate of the band gap.

The system is found to have two locally stable states: one in which the polarization of the BaTiO<sub>3</sub> layer points away from the BaTiO<sub>3</sub>/n-SrTiO<sub>3</sub> interface, and one in which the polarization points into the interface. As previously discussed [12], in the former case, the depolarization field is screened by a combination of depletion of electrons and polar lattice distortions in the region of n-SrTiO<sub>3</sub> near the interface. The BaTiO<sub>3</sub> layers are insulating, and in addition, the conduction band minimum in the SrTiO<sub>3</sub> layers adjacent to the interface is pushed up above the Fermi level, so that these layers are insulating as well. For polarization pointing into the interface, in addition to the accumulation of electrons and polar lattice distortions in the interface region of n-SrTiO<sub>3</sub>, electrons are transferred into the interface layers of BaTiO<sub>3</sub>, making a substantial additional contribution to the screening. The downward bending of the bands metallizes the ferroelectric interface layers. In addition, the free carriers reduce their polar distortion, consistent with experimental and theoretical results that show that the polar distortion of bulk BaTiO<sub>3</sub> is reduced by electron doping through oxygen vacancy or substitution of Ba by La but remains nonzero up to a La concentration of 0.15 [15, 16,17]. Finally, we note that in this geometry, the two polarization states are inequivalent, with the magnitude of the polarization pointing into the interface being smaller than that pointing away from the interface, due to the dissimilar electrodes (n-SrTiO<sub>3</sub> and SrRuO<sub>3</sub>).



FIG. 2. Excess electrons in each unit cell layer for two polarization directions, obtained by integrating the occupation of the local density of states above the conduction band minimum presented in Fig. 2 of Ref [12]. Arrows indicate the direction of polarization. The dashed line indicates the excess electron density in bulk n-SrTiO<sub>3</sub>.

The excess electron density profile is computed by integrating the occupation of the local density of states above the conduction band minimum in each unit cell layer. The profile from the middle layer of BaTiO<sub>3</sub> to the midpoint of the n-SrTiO<sub>3</sub> layer is shown in Fig. 2. When polarization is pointing away from the interface, the excess electron density in n-SrTiO<sub>3</sub> is reduced below the doping level of 0.09 electrons/u.c even well away from the interface, producing a wide depletion region. In the supercell considered, these electrons are transferred to the SrRuO<sub>3</sub> layer. When polarization is pointing into the interface, conduction band levels are occupied in the two layers of BaTiO<sub>3</sub> at the interface, and the excess election density increases above the doping level at the interface and in the two adjacent layers of n-SrTiO<sub>3</sub>. In addition to transfer of electrons from the SrRuO<sub>3</sub> electrode (not shown), we note that electrons are also transferred from the n-SrTiO<sub>3</sub> layers away from the interface.

In Figure 3, we present plots of the spatial dependence of the density of states near the Fermi level, analogous to those presented in Ref. [11]. When the polarization points away from the  $BaTiO_3/n-SrTiO_3$  interface, the density of states near the Fermi level in the first three layers of  $n-SrTiO_3$  is dramatically reduced. When polarization points into the  $BaTiO_3/n-SrTiO_3$  interface, the density of states near the Fermi level in the matrix three layers of  $n-SrTiO_3$  is dramatically reduced. When polarization points into the  $BaTiO_3/n-SrTiO_3$  interface, the density of states near the Fermi level in the matrix of states near the fermi level in the matrix of states near the fermi level in the matrix of states near the fermi level in the matrix of states near the fermi

interface layers of  $n-SrTiO_3$  increases slightly and the two interface layers of BaTiO<sub>3</sub> are metallized.

In Figure 4, we show the effect of the polarization direction on the conduction band states in BaTiO<sub>3</sub> near the interface by projecting the Ti d bands of BaTiO<sub>3</sub> in the first six unit cell layers [18]. When the polarization points away from the BaTiO<sub>3</sub>/n-SrTiO<sub>3</sub> interface, these states are above the Fermi level, as shown by Figure 4(a). When polarization points into the BaTiO<sub>3</sub>/n-SrTiO<sub>3</sub> interface, these states are shifted down in energy, and two bands cross the Fermi level as shown in Figure 4 (b), resulting in metallic character of the layers.



FIG. 3. A 2D projection of the spatial dependence of the local density of electronic states derived from firstprinciples calculations integrated within  $\pm k_BT$  eV of the Fermi level with T=300K near the interface BaTiO<sub>3</sub>/n-SrTiO<sub>3</sub> for (a) polarization pointing away from the interface, and (b) polarization pointing into the interface.

To predict whether electrons will be transferred into the ferroelectric in the ON state (polarization directed into the interface), we adapt the electrostatic model used in the previous paper [26]. The model describes each electrode (SrRuO<sub>3</sub> and n-SrTiO<sub>3</sub>) by its screening length, relative dielectric constant, and Fermi level relative to the vacuum reference, and the ferroelectric by its polarization and conduction band minimum relative to the vacuum reference. As described in detail in the Appendix, for each direction of the polarization we compute the electrostatic potential assuming no transfer of electrons into the ferroelectric gate. The electrostatic potential at each ferroelectric/electrode interface, called the screening potential  $\varphi$ , increases with the screening length of the electrode and the spontaneous polarization of the ferroelectric. The electron transfer is determined by the relative values of  $\varphi$  and  $\Delta \Phi$ , the difference between the conduction band minimum of the ferroelectric and the Fermi level of the doped semiconductor. If  $\Delta \Phi > 0$  and  $\varphi$  is smaller than  $\Delta \Phi$ , then no carriers are transferred into the ferroelectric in either polarization state. If the barrier  $\Delta \Phi$  is smaller than  $\varphi$ , then for polarization pointing into the interface, the electrostatic potential lowers the conduction band of the ferroelectric near the interface below the Fermi level, and electrons are transferred into the interface lavers of the ferroelectric and contribute to the conductance. This transfer is promoted by a small difference between the conduction band minimum of the ferroelectric and the Fermi level of the doped semiconductor, and by a large spontaneous polarization.



FIG. 4. Bands structure of the (a) Off state and (b) On state projected on  $BaTiO_3$  layers near the interface. The dashed line indicates the Fermi level of the heterostructure.

The transfer of electrons in the SrRuO<sub>3</sub>/BaTiO<sub>3</sub>/n-SrTiO<sub>3</sub> system can be readily understood within this model. An estimate for the band offset  $\Delta \Phi$  can be obtained from the measured electron affinities of the strained tetragonal BaTiO<sub>3</sub> and SrTiO<sub>3</sub> compounds respectively. These are both about 4.0 eV, giving a value of  $\Delta \Phi$  close to zero. A first-principles estimate for  $\Delta \Phi$ can be obtained by lining up the centers of the oxygen 2p bands for the computed strained tetragonal structures, as described in Refs. [19,20]. With LDA, the conduction band minima are 2.90 eV and 3.10 eV above the lined up oxygen 2p center for SrTiO<sub>3</sub> and BaTiO<sub>3</sub>, giving a value of  $\Delta \Phi$  of 0.2 eV. Since the LDA errors in the band gaps could affect this result, we performed calculations for the strained tetragonal compounds with the Heyd-Scuseria-Ernzerhof (HSE) hybrid functional [21]. This functional gives band gaps which match experiment very well. By lining up the oxygen 2p centers, we find that the conduction band minima are at 4.87 eV and 4.90 eV for SrTiO<sub>3</sub> and BaTiO<sub>3</sub>, giving a value of  $\Delta \Phi$  of 0.03 eV. As this is much smaller than the value of the screening potential  $\varphi \approx 1$  eV estimated in the Appendix from the polarization of BaTiO<sub>3</sub> and screening length of n-SrTiO<sub>3</sub> (we assume the screening length of n-SrTiO<sub>3</sub> is larger than 0.1 nm), resulting in electron transfer into the BaTiO<sub>3</sub> in the on state.



Fig. 5. Excess electrons in each unit cell layer for two polarization directions, obtained by integrating the occupation of the local density of states above the conduction band minimum as is shown in Figure 2.

PbTiO<sub>3</sub> has a smaller electron affinity than BaTiO<sub>3</sub> (about 3.5 eV), which would increase  $\Delta \Phi$ , decreasing this effect. An HSE calculation analogous to that above gives the conduction band minimum of PbTiO<sub>3</sub> as 5.30 eV and  $\Delta \Phi$  of 0.43 eV (the LDA calculation gives conduction band minimum 3.20 eV and  $\Delta \Phi$  of 0.30 eV). However, PbTiO<sub>3</sub> also has a larger polarization than BaTiO<sub>3</sub>, which increases the screening potential at the PbTiO<sub>3</sub>/n-SrTiO<sub>3</sub>. and would increase the effect. By performing firstprinciples calculation on a SrRuO<sub>3</sub>/PbTiO<sub>3</sub>/n-SrTiO<sub>3</sub> heterostructure, shown in the two figures Figures 5 and 6, we find that the net effect is comparable to what was found in SrRuO<sub>3</sub>/PbTiO<sub>3</sub>/n-SrTiO<sub>3</sub>. Specifically, our calculation indicates the metallization of more than two layers of PbTiO<sub>3</sub> near the PbTiO<sub>3</sub>/n-SrTiO<sub>3</sub> interface when polarization is pointing into the interface.

The central role of  $\Delta \Phi$  suggests that the degree of metallization can be increased or decreased by modifications of the interface that change the band alignment. Previous theoretical and experimental studies have explored various types of interface engineering. For example, it was demonstrated that stoichiometry of the interfacial La<sub>1-x</sub>Sr<sub>x</sub>O layer at the La<sub>0.7</sub>Sr<sub>0.3</sub>MnO<sub>3</sub>/SrTiO<sub>3</sub> interface can be used to control the Schottky barrier height [ 22 , 23 ]. It was also shown that A-site composition allows tuning of the band offset at the Ba<sub>1-x</sub>Sr<sub>x</sub>TiO<sub>3</sub>/Ge interface [24].



Fig. 6. A 2D projection of the local density of electronic states, computed from first-principles calculations, integrated within  $\pm k_B T$  eV of the Fermi level with T=300K near the PbTiO<sub>3</sub>/n-SrTiO<sub>3</sub> interface as is shown in Figure 3.

The conductivity of (Ba, La)TiO<sub>3</sub> has been measured at room temperature with different doping levels, yielding a value of mobility of several cm<sup>2</sup>V<sup>-1</sup>s<sup>-1</sup>. At room temperature, the scattering is dominated by phonons. At low temperatures, the separation of the free carriers in the ferroelectric interface layer from the impurity atoms in the doped semiconductor should result in substantially enhanced on-state conductivity and on/off ratio. As is pointed out in [25], tuning the strain could further enhance the mobility of the system. In fact, the epitaxial growth of BaTiO<sub>3</sub> and PbTiO<sub>3</sub> on SrTiO<sub>3</sub> introduce considerable strain on ferroelectric. Therefore, we can still expect the additional channel in ferroelectric has higher conductivity.

In summary, we have investigated the active involvement of the ferroelectric gate in the conductance of a FeFET from first principles calculations and modeling. We showed that this involvement, based on polarization-dependent modulation doping, is promoted by minimizing the work function difference between the ferroelectric and the doped semiconductor and maximizing the ferroelectric polarization. Enhancement of the on-off ratio could thus be achieved with use of a high-mobility ferroelectric. Our first-principles results for BaTiO<sub>3</sub>/n-SrTiO<sub>3</sub> and PbTiO<sub>3</sub>/n-SrTiO<sub>3</sub> illustrate the mechanism and are practical starting points for experimental investigation of this effect.

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#### **APPENDIX**

#### **A: Electrostatic Model**

Consider a ferroelectric capacitor with a nonzero spontaneous polarization. Due to the imperfect screening of the electrodes, this polarization results in nonzero screening potentials near the interfaces. Because the potential must be continuous, the imperfect screening leads to the bending of the bands of the ferroelectric up or down, depending on the direction of the ferroelectric polarization. We compare the band bending to the barrier height, defined as the difference between the work function of the electrode and the conduction band minimum of the ferroelectric. For good metal electrodes, the screening length is less than 0.1 nanometers and the potential drop near the interface is smaller than the barrier height. However, if the screening length is large enough, as might happen when the electrode is a doped semiconductor, the screening potential near the interface could be larger than the barrier height, leading to charge transfer between the electrode and the ferroelectric.

We model this effect using the approximation of the Thomas-Fermi model of screening, In that case, the screening potential profiles near the two (left and right) interfaces are given by:[26]

$$\phi_{l}(z) = \frac{\sigma_{s} \delta_{l} e^{-|z|/\delta_{l}}}{\varepsilon_{0}} \text{ and }$$
$$\phi_{r}(z) = \frac{\sigma_{s} \delta_{r} e^{-|z-d|/\delta_{r}}}{\varepsilon_{0}}$$

where z is the distance from the interface, with z=0 means screening potential drop at the interface.  $\sigma_s$  is the magnitude of the screening charge density, given by  $\sigma_s = \frac{dP}{\epsilon(\delta_l + \delta_r) + d}$ .

d is the thickness of the ferroelectric film and P is the polarization.  $\varepsilon_0$  is the dielectric constant of vacuum level

and  $\varepsilon$  is the dielectric constant of the ferroelectric. We fix the screening length of the left interface to be  $\delta_1 =$ 0.1 nm and find the screening potential of the right interface as a function of screening length  $\delta_r$ . We take the thickness of the ferroelectric layer to be d =5 nm and the relative dielectric constant of the ferroelectric to be  $\varepsilon = 100$ , which are typical values for ferroelectric thin films [27].



Fig. 1s Screening potential as a function of screening length of the right electrode, with screening length of the left electrode fixed at 0.1 nm.

Fig. 1s shows the calculated dependence of the screening potential on screening length in two cases, one with polarization  $P = 40 \ \mu C/cm^2$  and the other with polarization  $P = 80 \ \mu C/cm^2$ , corresponding to compressively strained BaTiO<sub>3</sub> and PbTiO<sub>3</sub>, respectively. We see that the screening length has a dramatic effect on the screening potential. If the screening length of the right electrode is larger than 1 nm, the screening potential is more than 1 eV. When this screening potential is larger than the barrier height at the interface, then the conduction bands of the ferroelectric layer bend down below the Fermi level of the system for polarization pointing into the electrode, which will result in the transfer of electrons into the ferroelectric.

#### **B:** First principles calculations

By using the implementation in Quantum ESPRESSO to calculate the electrostatic potential profile of the SrRuO<sub>3</sub>/BaTiO<sub>3</sub>/n-SrTiO<sub>3</sub> system for each polarization direction, we can estimate a lower bound for the screening potential discussed above. As shown in Fig. 2s, the electrostatic potential energy at the interface of BaTiO<sub>3</sub>/n-SrTiO<sub>3</sub> shifts by about 0.64 eV between the

two polarization states. We divide by two to get a lower bound of 0.32 eV as the screening potential induced by polarization, as the model value is reduced by partially screening by the electron transfer in the ON state. From Fig 1s, we get a lower bound on the screening length of about 0.03 nm.



Fig. 2s Electrostatic potential profile of the  $SrRuO_3/BaTiO_3/n-SrTiO_3$  for two opposite polarization orientations.

From the electrostatic potential profile for the  $SrRuO_3/PbTiO_3/n-SrTiO_3$  system shown in Fig. 3s, we similarly estimate a lower bound on the screening potential at the  $PbTiO_3/n-SrTiO_3$  interface of about 0.57 eV. From Fig 1s, we get a lower bound on the screening length of 0.02 nm, comparable to that obtained from the electrostatic potential profile in the BaTiO\_3 case.



Fig. 3s Electrostatic potential profile of the SrRuO<sub>3</sub>/PbTiO<sub>3</sub>/n-SrTiO<sub>3</sub> for two opposite polarization directions.

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